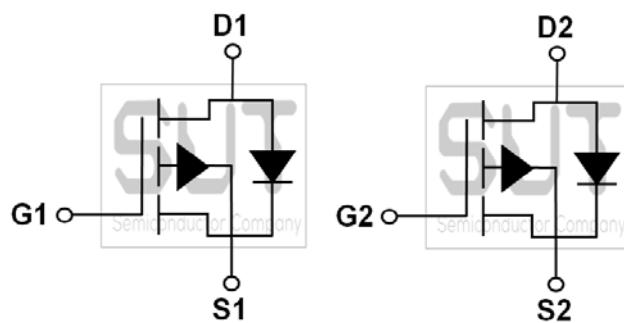
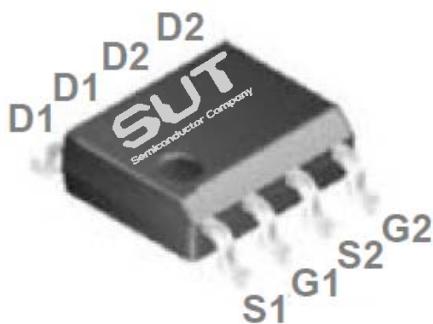


P-Channel 40-V_(D-S) MOSFET

PRODUCT SUMMARY		
B _{VDS} (V)	R _{DS(on)} (mΩ)(MAX)	I _D (A)
-40	38@V _{GS} =-10V	-7.2

SOP8 Pin Configuration



ABSOLUTE MAXIMUM RATINGS(T_C=25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	-40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous (T _C =25°C)	I _D	7.2	A
Drain Current-Continuous (T _C =100°C)		4.5	A
Drain Current-Pulsed ¹	I _{DM}	28.8	A
Power Dissipation (T _C =25°C)	P _D	2.5	W
Power Dissipation-Derate above 25°C		0.02	W/°C
Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 150	°C

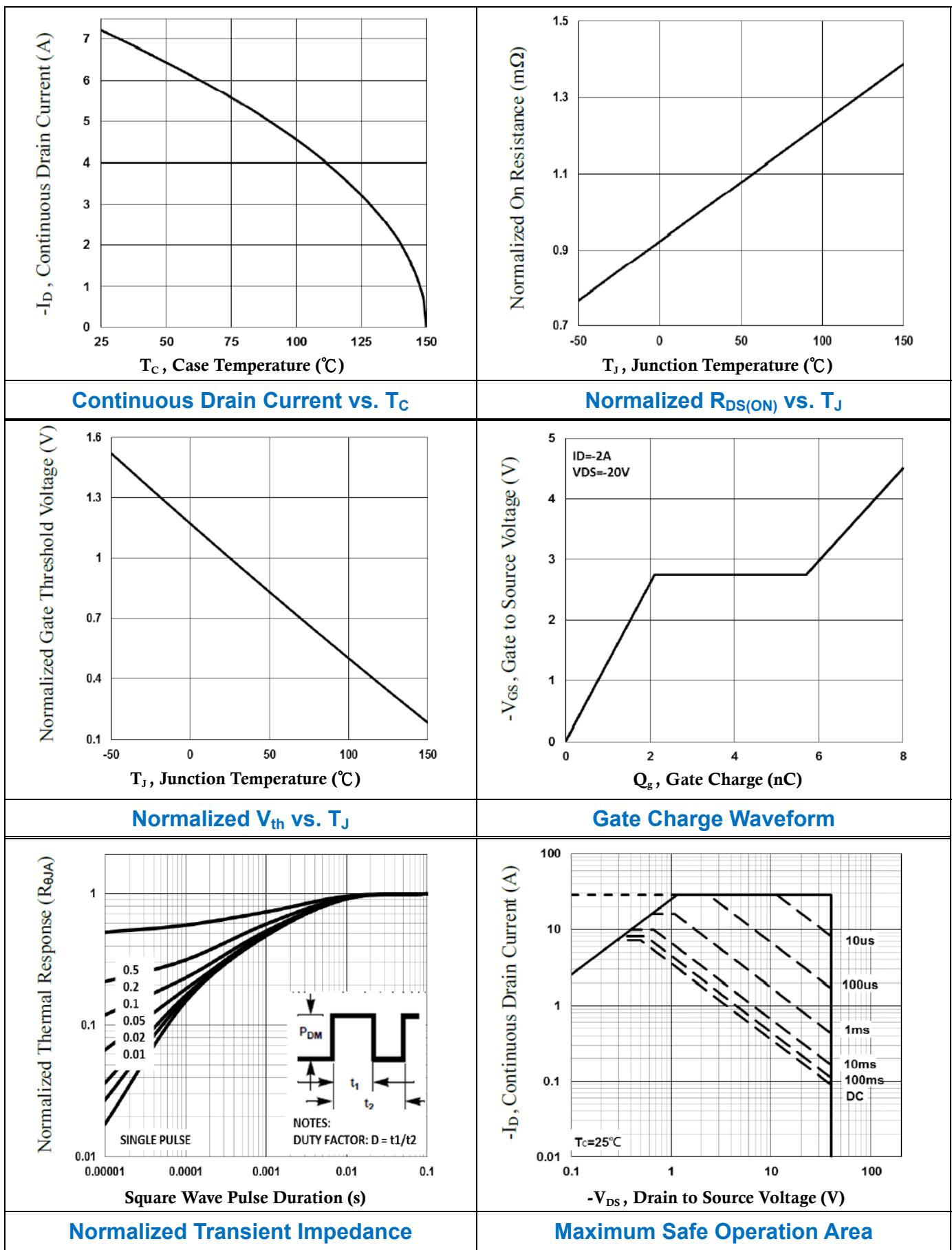
THERMAL CHARACTERISTICS

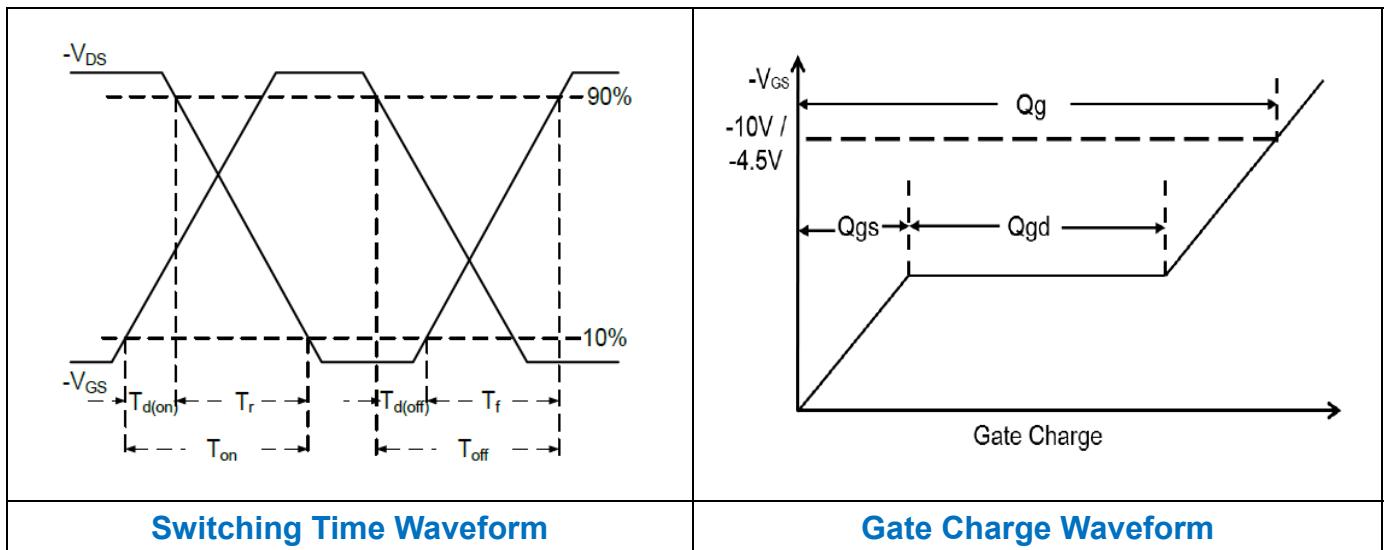
Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to Case	R _{θJC}	---	50	°C/W
Thermal Resistance Junction to Ambient	R _{θJA}	---	62	°C/W

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-40	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Reference to 25°C , $I_D=-1\text{mA}$	---	-0.04	---	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-40\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-32\text{V}$, $T_J=125^\circ\text{C}$	---	---	-10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 10\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
On Characteristics						
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=-10\text{V}$, $I_D=-4\text{A}$	---	30	38	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-2\text{A}$	---	42	55	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=-250\mu\text{A}$	-1.0	-1.6	-2.5	V
$V_{\text{GS(th)}}$ Temperature Coefficient	$\Delta V_{\text{GS(th)}}$		---	3.0	---	$\text{mV}/^\circ\text{C}$
Forward Transconductance	g_{fs}	$V_{\text{DS}}=-10\text{V}$, $I_D=-3\text{A}$	---	5.0	---	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{2, 3}	Q_g	$V_{\text{GS}}=-4.5\text{V}$, $V_{\text{DS}}=-20\text{V}$, $I_D=-2\text{A}$	---	8.0	16	nC
Gate-Source Charge ^{2, 3}	Q_{gs}		---	2.1	4.2	
Gate-Drain Charge ^{2, 3}	Q_{gd}		---	3.6	7.2	
Turn-On Delay Time ^{2, 3}	$T_{\text{d(on)}}$	$V_{\text{GS}}=-4.5\text{V}$, $V_{\text{DD}}=-20\text{V}$, $R_G=25\Omega$, $I_D=-1\text{A}$	---	20	40	ns
Rise Time ^{2, 3}	T_r		---	12	24	
Turn-Off Delay Time ^{2, 3}	$T_{\text{d(off)}}$		---	46	80	
Fall Time ^{2, 3}	T_f		---	6.0	12	
Input Capacitance	C_{iss}	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-15\text{V}$, $F=1\text{MHz}$	---	1050	1600	pF
Output Capacitance	C_{oss}		---	110	160	
Reverse Transfer Capacitance	C_{rss}		---	80	120	
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0\text{V}$, Force Current	---	---	-7.2	A
Pulsed Source Current	I_{SM}		---	---	-14.4	A
Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_S=-1\text{A}$, $T_J=25^\circ\text{C}$	---	---	-1.0	V

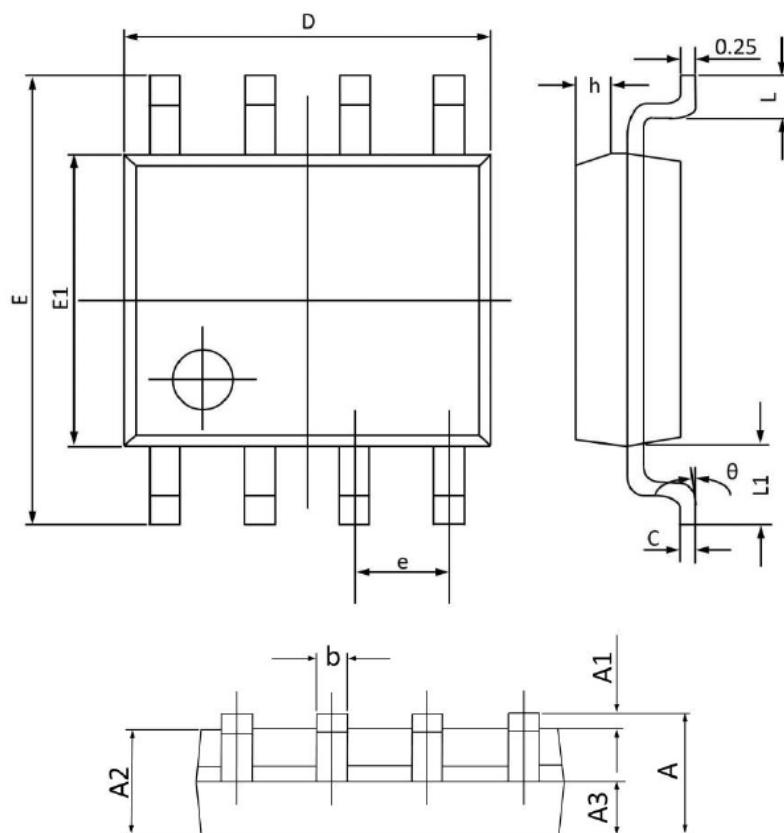
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.





SOP8 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.750	1.350	0.068	0.053
A1	0.250	0.100	0.009	0.004
A2	1.500	1.300	0.059	0.052
A3	0.700	0.600	0.027	0.024
b	0.480	0.390	0.018	0.016
c	0.260	0.210	0.010	0.009
D	5.100	4.700	0.200	0.186
E	6.200	5.800	0.244	0.229
E1	4.100	3.700	0.161	0.146
e	1.270(BSC)		0.050(BSC)	
h	0.500	0.250	0.019	0.010
L	0.800	0.500	0.031	0.019
L1	1.050(BSC)		0.041(BSC)	
θ	8°	0°	8°	0°